

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT2930682

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
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HIROAKI IMAI	03/03/2014
YUYA OAKI	03/03/2014
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Property Type	Number
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PATENT

ASSIGNMENT

THIS INSTRUMENT OF ASSIGNMENT WITNESSE THAT:

WHEREAS, we, Hiroto WATANABE, Hiroaki IMAI and Yuya OAKI

residents of

c/o TOKYO METROPOLITAN INDUSTRIAL TECHNOLOGY RESEARCH
INSTITUTE, 4-10, Aomi 2-chome, Koto-ku, Tokyo 135-0064, Japan, c/o Faculty of
Science and Technology, Keio University, 14-1, Hiyoshi 3-chome, Kohoku-ku,
Yokohama-shi, Kanagawa 223-8522, Japan and c/o Faculty of Science and Technology,
Keio University, 14-1, Hiyoshi 3-chome, Kohoku-ku, Yokohama-shi, Kanagawa 223-
8522, Japan
respectively, have invented improvements in

METHOD FOR PRODUCING A PARTICLE CONTAINING POROUS SILICA,
POROUS SILICA, AND A PARTICLE CONTAINING POROUS SILICA

for which we have executed on even date herewith an application for Letters Patent of the
United States, and

WHEREAS, TOKYO METROPOLITAN INDUSTRIAL TECHNOLOGY RESEARCH
INSTITUTE

a corporation of the Japan

having a place of business at 4-10, Aomi 2-chome, Koto-ku, Tokyo 135-0064, Japan
is desirous of acquiring an interest in said invention, said application and the Letters Patent
to be issued therefor;

NOW, THEREFORE, to all whom it may concern, be it known that for and in
consideration of the sum of ONE DOLLAR to each in hand paid and other good and
valuable consideration, the receipt whereof is hereby acknowledged, we have sold,
assigned and set over, and do hereby sell, assign and set over to said corporation, its
successors or assigns, the entire right, title and interest to and in said invention in the
United States and in all foreign countries, said United States application for Letters Patent
therefor and the Letters Patent when issued; and we do hereby authorize and request the

Commissioner of Patent and Trademarks to issue the Letters Patent based upon said application to said corporation as the assignees of our entire right, title and interest to and in the same, for the sole use and behoof of said corporation, its successors or assigns.

And we also hereby covenant and agree to sign all proper papers including divisional and other applications for patents and assignments thereof in the United States and application for patents and assignments in all foreign countries, and to execute all rightful oaths and to take any other proper action that may in the judgment of the said corporation be necessary for securing thereto full rights to said invention, all of the foregoing to be at the expense of said corporation.

IN TESTIMONY WHEREOF, we have hereunto set our hands and affixed our seals.

Date

Date

Date

By _____

Hiroto WATANABE

By _____

Hiroaki IMAI

By _____

Yuya OAKI

